Product data sheet





- Soldering bathes
- WXS B200 Soldering bath 200 W 24 V
- Accessory for WX / WXD and WXA series soldering, desoldering and hot air stations
- For tin coating and preparation of electronics components and leads
- Precision temperature control / 200° F 930°F / 100° C 500° C
- Heated surface 200 W: Soldering bath 2.3"x 1.2" x 0.75" / 58 mm x 30 mm x 19 mm
- Heat-up time ~ 10 min (50°C 350°C)
- For lead free solder

WXSB 200 Soldering bath

Product no.: T0052704399N

Dimensions L x W x H (mm)	175 x 120 x 54
Dimensions L x W x H (inches)	6.89 x 4.72 x 2.13
Weight (approx.) in kg	
Voltage	24 V
Power	200 W
Channels	
Temperature range (depends on tool) °C	
Temperature range (depends on tool) °F	
Temperature accuracy °C	
Temperature accuracy °F	
Temperature accuracy for hot air °C	
Temperature accuracy for hot air °F	
Temperature stability °C	
Temperature stability °F	
Equipotential bonding socket	
Display	
Additional vacuum pump	
Max. hot air flow rate I/min (depends on tool)	
Capacity I/min	
Max. vacuum	
Interface	